

STPS16035T(V) STPS16045T(V)

POWER SCHOTTKY RECTIFIER

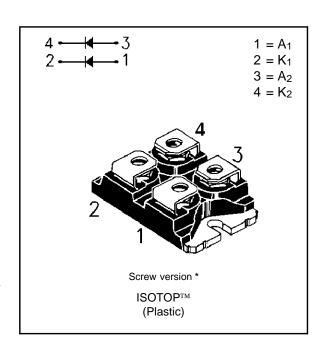
FEATURES

- VERY SMALL CONDUCTION LOSSES
- NEGLIGIBLE SWITCHING LOSSES
- LOW FORWARD VOLTAGE DROP
- LOW THERMAL RESISTANCE
- EXTREMELY FAST SWITCHING
- INSULATED PACKAGE : Insulating voltage = 2500 V_(RMS)

DESCRIPTION

Dual power schottky rectifier suited for switchmode power supply and high frequency DC to DC converters.

Packaged in ISOTOPTM, this device is intended for use in low voltage, high frequency inverters, free wheeling and polarity protection applications.



ABSOLUTE RATINGS (limiting values)

Symbol	Parameter			Value	Unit
IF(RMS)	RMS forward current		Per diode	125	Α
I _{F(AV)}	Average forward current	Tc=85°C δ = 0.5	Per diode Per device	80 160	A A
IFSM	Surge non repetitive forward current	tp=10ms sinusoidal	Per diode	900	А
IRRM	Peak repetitive reverse current	tp=2μs F=1KHz	Per diode	2	А
Tstg Tj	Storage and junction temperature range			- 65 to + 150 - 65 to + 150	°C °C
dV/dt	Critical rate of rise of reverse voltage			1000	V/μs

Symbol	Parameter	ST	PS	Unit
		16035TV	16045TV	
VRRM	Repetitive peak reverse voltage	35	45	V

^{*:} Tin plated Fast-on version is also available (without V suffix).

March 1992 1/5

TM: ISOTOP is a trademark of SGS-THOMSON Microelectronics.

STPS16035T(V) / STPS16045T(V)

THERMAL RESISTANCES

Symbol	Parameter		Value	Unit
Rth (j-c)	Junction to case	Per diode	0.9	°C/W
		Total	0.5	
Rth (c)	Coupling		0.1	°C/W

When the diodes 1 and 2 are used simultaneously:

 Δ Tj(diode 1) = P(diode) x Rth(Per diode) + P(diode 2) x Rth(c)

ELECTRICAL CHARACTERISTICS (Per diode)

STATIC CHARACTERISTICS

Symbol	Test Conditions			Тур.	Max.	Unit
I _R *	T _j = 25°C	$V_R = V_{RRM}$			1	mA
	T _j = 125°C				150	mA
VF **	T _j = 125°C	IF = 160 A			0.90	V
	T _j = 125°C	IF = 80 A			0.69	
	T _j = 25°C	IF = 160 A			0.95	

Pulse test: * tp = 5 ms, duty cycle < 2 %

To evaluate the conduction losses use the following equation : $P = 0.48 \times I_{F(AV)} + 0.00262 \times I_{F^2(RMS)}$

Fig.1 : Average forward power dissipation versus average forward current. (Per diode)

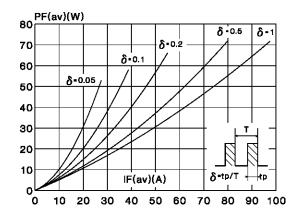
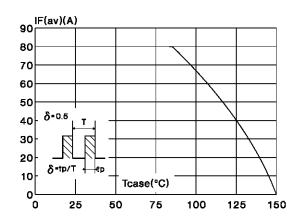


Fig.2: Average current versus case temperature. (duty cycle: 0.5) (Per diode)



^{**} tp = 380 μ s, duty cycle < 2 %

Fig.3: Non repetitive surge peak forward current versus overload duration. (Maximum values) (Per diode)

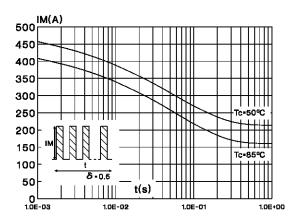


Fig.5: Reverse leakage current versus reverse voltage applied. (Typical values) (Per diode)

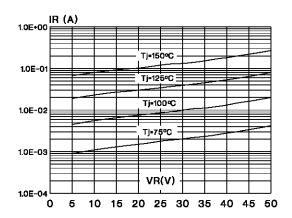


Fig.7: Forward voltage drop versus forward current. (Maximum values) (Per diode)

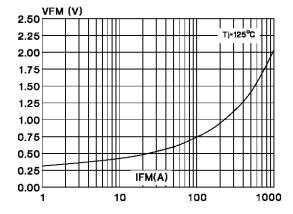


Fig.4: Relative variation of thermal transient impedance junction to case versus pulse duration.

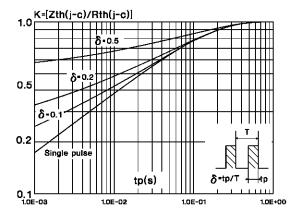
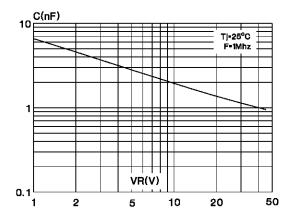
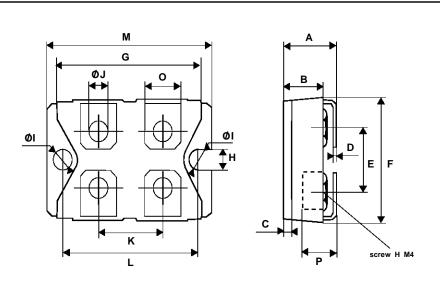


Fig.6 : Junction capacitance versus reverse voltage applied. (Typical values) (Per diode)



PACKAGE MECHANICAL DATA

ISOTOP



	DIMENSIONS				
REF.	Millimeters		Inches		
	Min.	Max.	Min.	Max.	
Α	11.80	12.20	0.465	0.480	
В	8.90	9.10	0.350	0.358	
С	1.95	2.05	0.077	0.081	
D	0.75	0.85	0.029	0.034	
E	12.60	12.80	0.496	0.504	
F	25.10	25.50	0.988	1.004	
G	31.50	31.70	1.240	1.248	
Н	4.00		0.157		
	4.10	4.30	0.161	0.169	
J	4.10	4.30	0.161	0.169	
K	14.90	15.10	0.586	0.595	
Ĺ	30.10	30.30	1.185	1.193	
М	37.80	38.20	1.488	1.504	
0	7.80	8.20	0.307	0.323	
Р	5.50		0.216		

Cooling method: C Marking: Type number
Weight: 28 g (without screw)
Electrical isolation: 2500V (RMS)
Capacuitance: < 45 pF

Inductance: < 5 nH

Recommended torque value: 1.3 N.m (MAX 1.6N.m) for the 6 x M4 screws. (2 x M4 screws recommended for mounting the package on the heatsink ant the 4 screws given with the screw version). The screws supplied with the package are adapted for mounting on a board (or other types of terminals) with a thickness of 0.6 mm min and 2..2 max.

Information furnished is believed to be accurate and reliable. However, SGS-THOMSON Microelectronics assumes no responsability for the consequences of use of such information nor for any infringement of patents or other rights of third parties which may results from its use. No license is granted by implication or otherwise under any patent or patent rights of SGS-THOMSON Microelectronics. Specifications mentioned in this publication are subject to change without notice. This publication supersedes and replaces all information previously supplied. SGS-THOMSON Microelectronics products are not authorized for use as critical components in life support devices or systems without express written approval of SGS-THOMSON Microelectonics.

© 1994 SGS-THOMSON Microelectronics - All Rights Reserved

TURBOSWITCH, TRANSIL, TRISIL, SNUBBERLESS are Trademarks of SGS-THOMSON Microelectronics.

SGS-THOMSON Microelectronics GROUP OF COMPANIES

Australia - Brazil - France - Germany - Hong Kong - Italy - Japan - Korea - Malaysia - Malta - Morocco - The Netherlands - Singapore - Spain - Sweden - Switzerland - Taiwan - Thailand - United Kingdom - U.S.A

